

# **SOT-23 Plastic-Encapsulate Switching Diode**

### **Features**

• 50nS; Fast Switching Device (TRR <50 nS)

• 350mW; Power Dissipation of 350mW

• High Stability and High Reliability

• Low reverse leakage





Marking:

**SOT-23** 

### **Mechanical Data**

• SOT-23 Small Outline Plastic Package

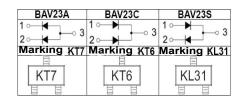
• Epoxy UL: 94V-0

• Mounting Position: Any

#### Pin definition

#### **Epuivalent circuit**





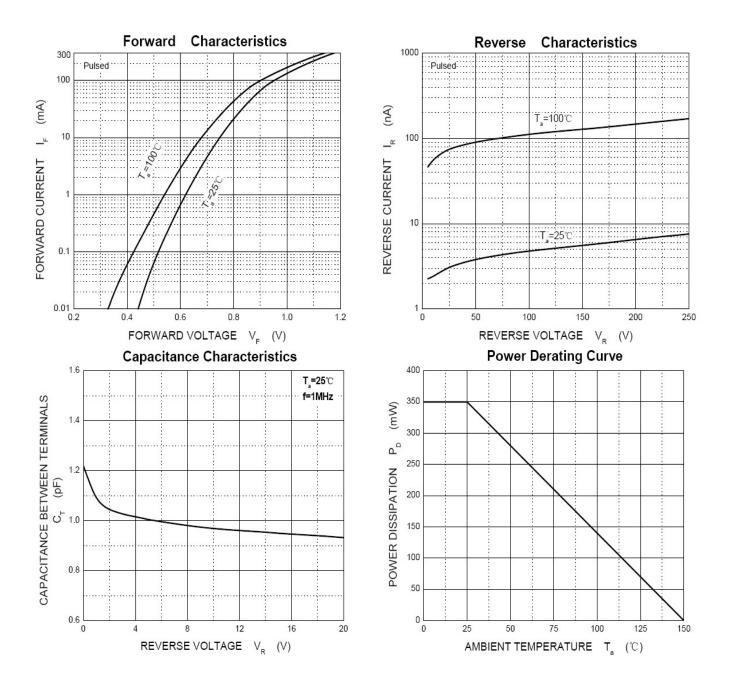
Maximum Ratings & Electrical Characteristics(TA=25°C unless otherwise noted)					
Parameter	Symbol	Value	Unit		
Reverse Voltage	$V_R$	250	V		
Peak Repetitive Reverse Voltage	$V_{RRM}$	175	V		
Power Dissipation	P <sub>D</sub>	350	mW		
Repetitive peak forward surge current	Io	225	mA		
Peak Forward Surge Current@tp=1us; TA=25℃	I <sub>FSM</sub>	1.7	А		
Operating junction temperature range	T <sub>J</sub>	150	°C		
Storage temperature range	T <sub>STG</sub>	-55 to +150	°C		
Thermal Resistance from Junction to Ambient	Rөла	357	°C/W		

Electrical Specifications(TA=25°C unless otherwise noted)					
Parameter	Symbol	Test Conditions	Limits		Unit
	Syllibol		Min	Max	Onit
Reverse Voltage	V(BR)	IR=100uA	250		V
Reverse Leakage Current	<b>I</b> R	VR=200V		0.1	uA
Forward Voltage	VF	IF=100mA		1.00	· V
	VF	IF=200mA		1.25	
Reverse Recovery Time	Trr	IF= IR=30mA RL=100Ω IRR=0.1 X IR		50	nS
Capacitance	Ст	VR=0V, f=1MHZ		5	pF



## **Ratings and Characteristics Curves**

(TA = 25°C unless otherwise noted)

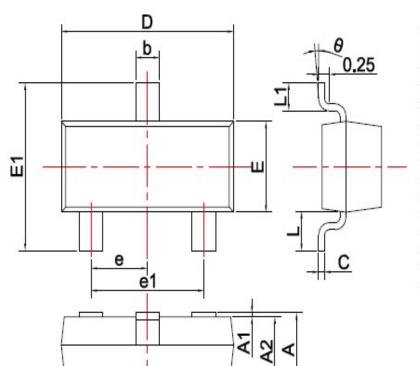






## **Package Outline Dimensions**

in inches (millimeters)



SYMBOL	DIMENSIONS		
	MIN.	MAX.	
Α	0.900	1.150	
A1	0.000	0.100	
A2	0.900	1.050	
b	0.300	0.500	
С	0.080	0.150	
D	2.800	3.000	
E	1.200	1.400	
E1	2.250	2.550	
е	0.950TYP		
e1	1.800	2.000	
L	0.550REF		
L1	0.300	0.500	
θ	0°	8°	

Unit: mm

## **Revision History**

Document Version	Date of release	Description of changes
Rev.A	2017.09.26	First issue





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